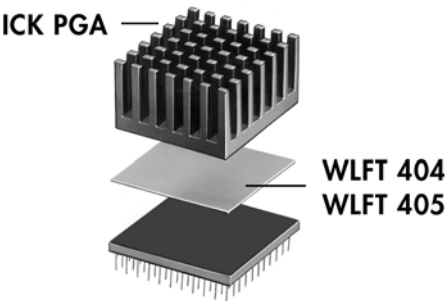
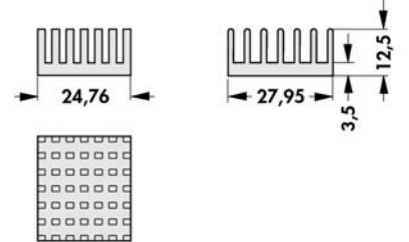
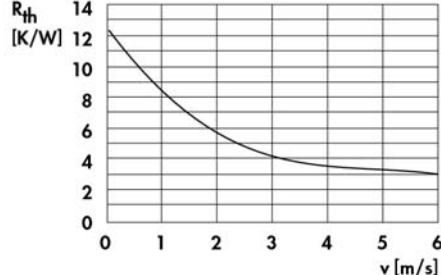
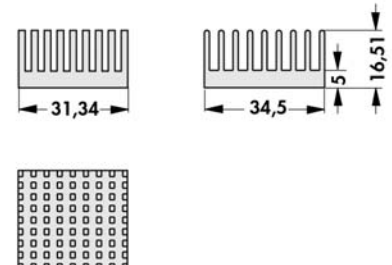
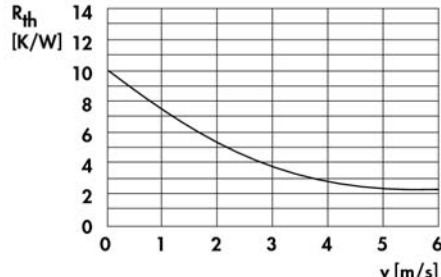
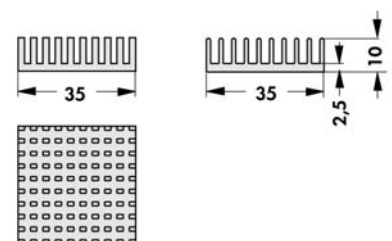
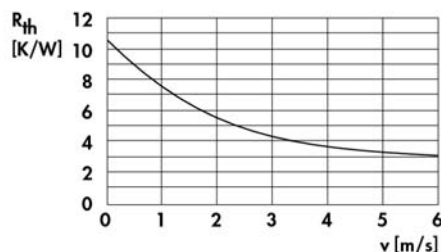
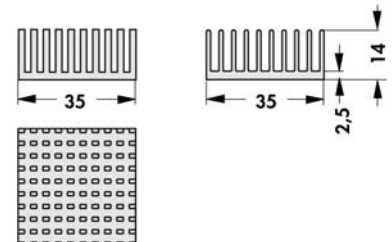
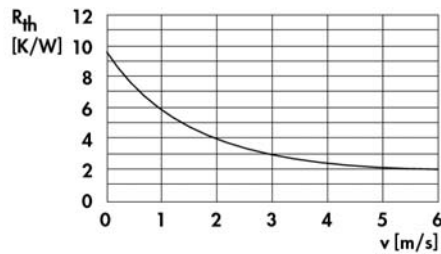
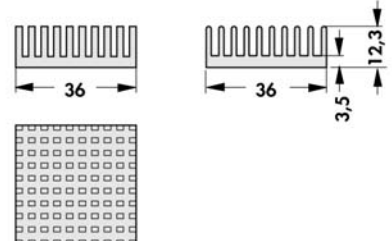
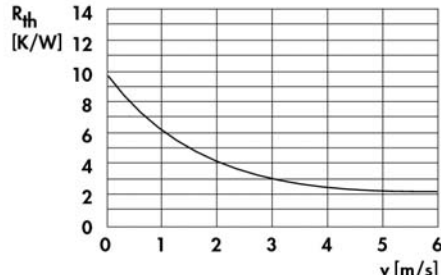
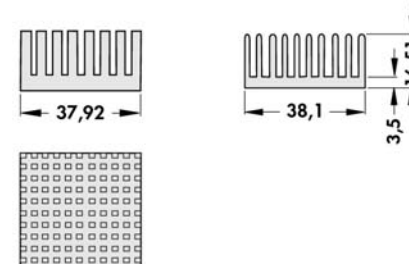
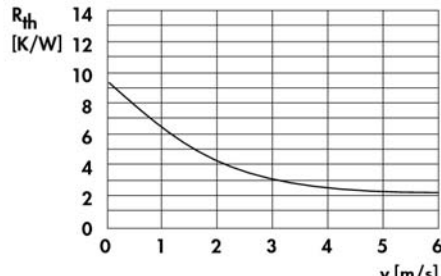


surface: black anodised



art. no.			
ICK PGA 6 x 6 x 14 WLF ... 14 x 14			
ICK PGA 8 x 8 x 12 WLF ... 23 x 23			
ICK PGA 9 x 9 WLF ... 24 x 24			
ICK PGA 11 x 11 x 8 WLF ... 24 x 27			
ICK PGA 11 x 11 WLF ... 24 x 27			

Heatsinks for PGA

art. no. ICK PGA 11 x 11 x 12 WLF ... 24 x 27		
art. no. ICK PGA 14 x 14 WLF ... 31 x 34		
art. no. ICK PGA 14 x 14 x 10 WLF ... 35 x 35		
art. no. ICK PGA 14 x 14 x 14 WLF ... 35 x 35		
art. no. ICK PGA 14 x 14 x 12 WLF ... 36 x 36		
art. no. ICK PGA 15 x 15 WLF ... 37 x 37		

B 11

Thermal conduct. foil WLFT 404/405 → E 5
Thermal conductive glue → E 15
Thermal conductive paste → E 13
Processor overview → B 2 - 9

SMD-heatsinks → B 38 - 40
Mounting material for semiconduct. → E 37 - 41
Hole pattern → A 21
Technical introduction → A 2 - 7